

EL465781956

DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated  
below next to my name.

I believe I am the original, first and joint inventor of the subject  
matter which is claimed and for which a patent is sought on the  
invention entitled: **Method Of Forming A Thin Film Transistor**, the  
specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents  
of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to  
be material to patentability as defined in Title 37, Code of Federal  
Regulations §1.56.

**PRIOR FOREIGN APPLICATIONS:**

I hereby state that no applications for foreign patents or inventor's  
certificates have been filed prior to the date of execution of this  
declaration.

**POWER OF ATTORNEY:**

As a named Inventor, I hereby appoint the following attorneys and  
agent to prosecute this application and transact all business in the  
Patent and Trademark Office connected therewith: Richard J. St. John,  
Reg. No. 19,363; David P. Roberts, Reg. No. 23,032; Randy A. Gregory,  
Reg. No. 30,386; Mark S. Matkin, Reg. No. 32,268; James L. Price, Reg.  
No. 27,376; Deepak Malhotra, Reg. No. 33,560; Mark W. Hendrickson,

1      Reg. No. 32,356; David G. Latwesen, Reg. No. 38,533; George G.  
2      Grigel, Reg. No. 31,166; Keith D. Grzelak, Reg. No. 37,144; John S.  
3      Reid, Reg. No. 36,369; W. Bryan Farney, Reg. No. 32,651 and Lia M.  
4      Pappas, Reg. No. 34,095.

5      Mail correspondence to: WILLIS, ST. JOHN, ROBERTS,  
6      GREGORY & MATKIN P.S., 601 W. First Avenue, Suite 1300, Spokane,  
7      WA 99204-0317. Direct telephone calls to: Mark S. Matkin,  
8      (509) 624-4276.

9      I hereby declare that all statements made herein of my own  
10     knowledge are true and that all statements made on information and  
11     belief are believed to be true; and further that these statements were  
12     made with the knowledge that willful false statements and the like so  
13     made are punishable by fine or imprisonment, or both, under  
14     Section 1001 of Title 18 of the United States Code and that such willful  
15     false statement may jeopardize the validity of the application or any  
16     patent issued therefrom.

17      \* \* \* \* \*

18     Full name of inventor: Gurtej S. Sandhu

19     Inventor's Signature: Gurtej S. Sandhu

20     Date: 1/17/96

21     Residence: Boise, Idaho

22     Citizenship: U.K.

23     Post Office Address: 2964 East Parkriver Drive  
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Full name of inventor: Shubneesh Batra

Inventor's Signature: 

Date: 1/22/96

Residence: Boise, Idaho

**Citizenship:** India

Post Office Address: 12166 W. Keates Drive  
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Full name of inventor: Pierre C. Fazan

Inventor's Signature: Krene V. Voss

Date: 1/19/96

Residence: Boise, Idaho

**Citizenship:** Switzerland

**Post Office Address: 2267 Illinois Ave.  
Boise, ID 83706**

Assistant Commissioner for Patents

Washington, D.C. 20231

**ASSOCIATE POWER OF ATTORNEY**

Please recognize James D. Shaurette, Reg. No. 39,833; Frederick M. Fliegel, Reg. No. 36,138; Donald B. Kenady, Reg. No. 40,045; James E. Lake, Reg. No. 44,854; Bernard Berman, Reg. No. 37,279 and Jennifer J. Taylor, Reg. No. P-48,711, whose post office address is 601 W. First Avenue, Suite 1300, Spokane, Washington 99201-3828, as an associate attorney or agent in the above-entitled application.

Date:

7/9/01

  
\_\_\_\_\_  
David G. Latwesen, Ph.D.  
Reg. No. 38,533